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1) \$40.00	otal fee (37 CFR 3		Name: WENDEROTH, LIND & PONA Attn: Nils E. Pedersen , Esq.
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PATENT REEL: 012339 FRAME: 0879

ASSIGNMENT

	paid to each of the undersigned
	Kazuhiro IKURŲMI
	Shoichi KAJIWARA, and
Insert Name(s) of Inventor(s)	Osamu KUMAZAWA
	the undersigned hereby sell(s) and assign(s) to
Insert Name(s) of Assignee(s)	Matsushita Electric Industrial Co., Ltd.
Address	of 1006, Oaza Kadoma, Kadoma-shi, Osaka-fu, Japan
	(hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as
Title of	METHOD AND APPARATUS FOR ADJUSTING IMPEDANCE OF
Invention	MATCHING CIRCUIT
Date of Signing of Application	for which an application for patent in the United States has been executed by the undersigned on
	May 8, May 8, and May 11, 2001, respectively.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

PATENT REEL: 012339 FRAME: 0880 The undersigned hereby grant(s) the firm of WENDEROTH, LIND & PONACK, L.L.P., 2033 K Street, N.W., Suite 800, Washington, DC 20006, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s). Date 8.5.2001, Name of Inventor Kazuliiro IKURUMI Kazuliiro Ukwrumi Date 8, 5, 200/, Name of Inventor Shoichi Kajiwara Shoichi Kajiwara Date // 5 200/ Name of Inventor Osamu KUMAZAWA Date ______, Name of Inventor _____ Date ______, Name of Inventor _____ Date ______, Name of Inventor _____ (This assignment should preferably be acknowledged before a United States Consul. If not, then the execution by the Inventor(s) should be witnessed by at least two witnesses who sign here.) Witness _____ **ACKNOWLEDGEMENT** This ______, day of ______, ____, before me personally came the above-named_____ to me personally known as the individual(s) who executed the foregoing assignment, who did acknowledge to me that he (they) executed the same of his (their) own free will for the purposes therein set forth. Official Signature SEAL Official Title The above application may be more particularly identified as follows: U.S. Application Serial No. ______Filing Date April 6, 2001

Applicant Reference Number 533281 Atty Docket No.2001-0409A/00177

Title of Invention METHOD AND APPARATUS FOR ADJUSTING IMPEDANCE OF

MATCHING CIRCUIT

RECORDED: 12/04/2001

PATENT REEL: 012339 FRAME: 0881